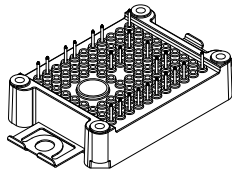


ACEPACK™ 1 converter inverter brake, 1200 V, 15 A, trench gate field-stop M series IGBT with soft diode and NTC



ACEPACK™ 1

Features

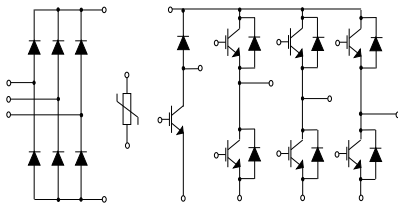
- ACEPACK™ 1 power module
 - DBC Cu Al₂O₃ Cu
- Converter inverter brake topology
 - 1600 V, very low drop rectifiers for converter
 - 1200 V, 15 A IGBTs and diodes
 - Soft and fast recovery diode
- Integrated NTC

Applications

- Inverters
- Motor drives

Description

This power module is a converter-inverter brake (CIB) topology in an ACEPACK™ 1 package with NTC, integrating the advanced trench gate field-stop technology from STMicroelectronics. This new IGBT technology represents the best compromise between conduction and switching loss, to maximize the efficiency of any converter system up to 20 kHz.



Product status

A1C15S12M3

Product summary

| | |
|-------------------|---------------------|
| Order code | A1C15S12M3 |
| Marking | A1C15S12M3 |
| Package | ACEPACK™ 1 |
| Leads type | Solder contact pins |

1 Electrical ratings

1.1 Inverter stage

Limiting values at $T_J = 25\text{ °C}$, unless otherwise specified.

1.1.1 IGBTs

Table 1. Absolute maximum ratings of the IGBTs, inverter stage

| Symbol | Description | Value | Unit |
|----------------|---|------------|------|
| V_{CES} | Collector-emitter voltage ($V_{GE} = 0$) | 1200 | V |
| I_C | Continuous collector current at $T_C = 100\text{ °C}$ | 15 | A |
| $I_{CP}^{(1)}$ | Pulsed collector current ($t_p = 1\text{ ms}$) | 30 | A |
| V_{GE} | Gate-emitter voltage | ± 20 | V |
| P_{TOT} | Total power dissipation of each IGBT ($T_C = 25\text{ °C}$, $T_J = 175\text{ °C}$) | 142.8 | W |
| T_{JMAX} | Maximum junction temperature | 175 | °C |
| T_{Jop} | Operating junction temperature range under switching conditions | -40 to 150 | °C |

1. Pulse width limited by maximum junction temperature.

Table 2. Electrical characteristics of the IGBTs, inverter stage

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-----------------------------|--------------------------------------|--|------|------|-----------|---------------|
| $V_{(BR)CES}$ | Collector-emitter breakdown voltage | $I_C = 1\text{ mA}$, $V_{GE} = 0\text{ V}$ | 1200 | | | V |
| $V_{CE(sat)}$ (terminal) | Collector-emitter saturation voltage | $V_{GE} = 15\text{ V}$, $I_C = 15\text{ A}$ | | 1.95 | 2.45 | V |
| | | $V_{GE} = 15\text{ V}$, $I_C = 15\text{ A}$, $T_J = 150\text{ °C}$ | | 2.3 | | V |
| $V_{GE(th)}$ | Gate threshold voltage | $V_{CE} = V_{GE}$, $I_C = 1\text{ mA}$ | 5 | 6 | 7 | V |
| I_{CES} | Collector cut-off current | $V_{GE} = 0\text{ V}$, $V_{CE} = 1200\text{ V}$ | | | 100 | μA |
| I_{GES} | Gate-emitter leakage current | $V_{CE} = 0\text{ V}$, $V_{GE} = \pm 20\text{ V}$ | | | ± 500 | nA |
| C_{ies} | Input capacitance | $V_{CE} = 25\text{ V}$, $f = 1\text{ MHz}$, $V_{GE} = 0\text{ V}$ | | 985 | | pF |
| C_{oes} | Output capacitance | | | 118 | | pF |
| C_{res} | Reverse transfer capacitance | | | 40 | | pF |
| Q_g | Total gate charge | $V_{CC} = 960\text{ V}$, $I_C = 15\text{ A}$, $V_{GE} = \pm 15\text{ V}$ | | 71 | | nC |
| $t_{d(on)}$ | Turn-on delay time | $V_{CC} = 600\text{ V}$, $I_C = 15\text{ A}$, $R_G = 22\text{ }\Omega$, $V_{GE} = \pm 15\text{ V}$, $di/dt = 820\text{ A}/\mu\text{s}$ | | 120 | | ns |
| t_r | Current rise time | | | 14.5 | | ns |
| $E_{on}^{(1)}$ | Turn-on switching energy | | | 0.59 | | mJ |
| $t_{d(off)}$ | Turn-off delay time | $V_{CC} = 600\text{ V}$, $I_C = 15\text{ A}$, $R_G = 22\text{ }\Omega$, $V_{GE} = \pm 15\text{ V}$, $dv/dt = 8200\text{ V}/\mu\text{s}$ | | 115 | | ns |
| t_f | Current fall time | | | 84 | | ns |
| $E_{off}^{(2)}$ | Turn-off switching energy | | | 0.83 | | mJ |

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-----------------|-------------------------------------|--|------|------|------|---------------------------|
| $t_{d(on)}$ | Turn-on delay time | $V_{CC} = 600\text{ V}$, $I_C = 15\text{ A}$, $R_G = 22\ \Omega$, $V_{GE} = \pm 15\text{ V}$, $di/dt = 690\text{ A}/\mu\text{s}$, $T_J = 150\text{ }^\circ\text{C}$ | | 122 | | ns |
| t_r | Current rise time | | | 17 | | ns |
| $E_{on}^{(1)}$ | Turn-on switching energy | | | 1.08 | | mJ |
| $t_{d(off)}$ | Turn-off delay time | $V_{CC} = 600\text{ V}$, $I_C = 15\text{ A}$, $R_G = 22\ \Omega$, $V_{GE} = \pm 15\text{ V}$, $dv/dt = 7000\text{ V}/\mu\text{s}$, $T_J = 150\text{ }^\circ\text{C}$ | | 122 | | ns |
| t_f | Current fall time | | | 146 | | ns |
| $E_{off}^{(2)}$ | Turn-off switching energy | | | 1.06 | | mJ |
| t_{SC} | Short-circuit withstand time | $V_{CC} \leq 600\text{ V}$, $V_{GE} \leq 15\text{ V}$, $T_{Jstart} \leq 150\text{ }^\circ\text{C}$ | 10 | | | μs |
| R_{THj-c} | Thermal resistance junction-to-case | Each IGBT | | 0.95 | 1.05 | $^\circ\text{C}/\text{W}$ |
| R_{THc-h} | Thermal resistance case-to-heatsink | Each IGBT, $\lambda_{grease} = 1\text{ W}/(\text{m}\cdot^\circ\text{C})$ | | 0.90 | | $^\circ\text{C}/\text{W}$ |

1. Including the reverse recovery of the diode.
2. Including the tail of the collector current.

1.1.2
Diode

 Limiting values at $T_J = 25\text{ °C}$, unless otherwise specified.

Table 3. Absolute maximum ratings of the diode, inverter stage

| Symbol | Parameter | Value | Unit |
|----------------|---|------------|------|
| V_{RRM} | Repetitive peak reverse voltage | 1200 | V |
| I_F | Continuous forward current at ($T_C = 100\text{ °C}$) | 15 | A |
| $I_{FP}^{(1)}$ | Pulsed forward current ($t_p = 1\text{ ms}$) | 30 | A |
| T_{JMAX} | Maximum junction temperature | 175 | °C |
| T_{Jop} | Operating junction temperature range under switching conditions | -40 to 150 | °C |

1. Pulse width limited by maximum junction temperature.

Table 4. Electrical characteristics of the diode, inverter stage

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|---------------------|-------------------------------------|---|------|------|------|---------------|
| V_F (terminal) | Forward voltage | $I_F = 15\text{ A}$ | - | 3.0 | 3.8 | V |
| | | $I_F = 15\text{ A}, T_J = 150\text{ °C}$ | - | 2.1 | | |
| t_{rr} | Reverse recovery time | $I_F = 15\text{ A}, V_R = 600\text{ V}, V_{GE} = \pm 15\text{ V},$ $di_F/dt = 820\text{ A}/\mu\text{s}$ | - | 190 | | ns |
| Q_{rr} | Reverse recovery charge | | - | 1.45 | | μC |
| I_{rrm} | Reverse recovery current | | - | 23 | | A |
| E_{rec} | Reverse recovery energy | | - | 0.55 | | mJ |
| t_{rr} | Reverse recovery time | $I_F = 15\text{ A}, V_R = 600\text{ V}, V_{GE} = \pm 15\text{ V},$ $di_F/dt = 690\text{ A}/\mu\text{s}, T_J = 150\text{ °C}$ | - | 400 | | ns |
| Q_{rr} | Reverse recovery charge | | - | 2.75 | | μC |
| I_{rrm} | Reverse recovery current | | - | 25 | | A |
| E_{rec} | Reverse recovery energy | | - | 1.2 | | mJ |
| R_{THj-c} | Thermal resistance junction-to-case | Each diode | - | 1.60 | 1.75 | °C/W |
| R_{THc-h} | Thermal resistance case-to-heatsink | Each diode, $\lambda_{grease} = 1\text{ W}/(\text{m}\cdot\text{°C})$ | - | 1.15 | | °C/W |

1.2 Brake stage

Limiting values at $T_J = 25\text{ °C}$, unless otherwise specified.

1.2.1 IGBT

Table 5. Absolute maximum ratings of the IGBT, brake stage

| Symbol | Parameter | Value | Unit |
|----------------|---|------------|--------------------|
| V_{CES} | Collector-emitter voltage ($V_{GE} = 0$) | 1200 | V |
| I_C | Continuous collector current ($T_C = 100\text{ °C}$) | 15 | A |
| $I_{CP}^{(1)}$ | Pulsed collector current ($t_p = 1\text{ ms}$) | 30 | A |
| V_{GE} | Gate-emitter voltage | ± 20 | V |
| P_{TOT} | Total power dissipation of each IGBT ($T_C = 25\text{ °C}$, $T_J = 175\text{ °C}$) | 142.8 | W |
| T_{JMAX} | Maximum junction temperature | 175 | $^{\circ}\text{C}$ |
| T_{Jop} | Operating junction temperature range under switching conditions | -40 to 150 | $^{\circ}\text{C}$ |

1. Pulse width limited by maximum junction temperature.

Table 6. Electrical characteristics of the IGBT, brake stage

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-----------------------------|--------------------------------------|---|------|------|-----------|---------------|
| $V_{(BR)CES}$ | Collector-emitter breakdown voltage | $I_C = 1\text{ mA}$, $V_{GE} = 0\text{ V}$ | 1200 | | | V |
| $V_{CE(sat)}$ (terminal) | Collector-emitter saturation voltage | $V_{GE} = 15\text{ V}$, $I_C = 15\text{ A}$ | | 1.95 | 2.45 | V |
| | | $V_{GE} = 15\text{ V}$, $I_C = 15\text{ A}$, $T_J = 150\text{ °C}$ | | 2.3 | | |
| $V_{GE(th)}$ | Gate threshold voltage | $V_{CE} = V_{GE}$, $I_C = 1\text{ mA}$ | 5 | 6 | 7 | V |
| I_{CES} | Collector cut-off current | $V_{GE} = 0\text{ V}$, $V_{CE} = 1200\text{ V}$ | | | 100 | μA |
| I_{GES} | Gate-emitter leakage current | $V_{CE} = 0\text{ V}$, $V_{GE} = \pm 20\text{ V}$ | | | ± 500 | nA |
| C_{ies} | Input capacitance | $V_{CE} = 25\text{ V}$, $f = 1\text{ MHz}$, $V_{GE} = 0\text{ V}$ | | 985 | | pF |
| C_{oes} | Output capacitance | | | 118 | | pF |
| C_{res} | Reverse transfer capacitance | | | 40 | | pF |
| Q_g | Total gate charge | $V_{CC} = 960\text{ V}$, $I_C = 15\text{ A}$, $V_{GE} = \pm 15\text{ V}$ | | 71 | | nC |
| $t_{d(on)}$ | Turn-on delay time | $V_{CC} = 600\text{ V}$, $I_C = 15\text{ A}$, $R_G = 22\ \Omega$, $V_{GE} = \pm 15\text{ V}$, $di/dt = 820\text{ A}/\mu\text{s}$ | | 120 | | ns |
| t_r | Current rise time | | | 14.5 | | ns |
| $E_{on}^{(1)}$ | Turn-on switching energy | | | 0.59 | | mJ |
| $t_{d(off)}$ | Turn-off delay time | $V_{CC} = 600\text{ V}$, $I_C = 15\text{ A}$, $R_G = 22\ \Omega$, $V_{GE} = \pm 15\text{ V}$, $dv/dt = 8200\text{ V}/\mu\text{s}$ | | 115 | | ns |
| t_f | Current fall time | | | 84 | | ns |
| $E_{off}^{(2)}$ | Turn-off switching energy | | | 0.83 | | mJ |
| $t_{d(on)}$ | Turn-on delay time | $V_{CC} = 600\text{ V}$, $I_C = 15\text{ A}$, $R_G = 22\ \Omega$, $V_{GE} = \pm 15\text{ V}$, $di/dt = 690\text{ A}/\mu\text{s}$, $T_J = 150\text{ °C}$ | | 122 | | ns |
| t_r | Current rise time | | | 17 | | ns |
| E_{on} | Turn-on switching energy | | | 1.08 | | mJ |

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|--------------|-------------------------------------|--|------|------|------|---------------------------|
| $t_{d(off)}$ | Turn-off delay time | $V_{CC} = 600 \text{ V}$, $I_C = 15 \text{ A}$, $R_G = 22 \Omega$, $V_{GE} = \pm 15 \text{ V}$, $dv/dt = 7000 \text{ V}/\mu\text{s}$, $T_J = 150 \text{ }^\circ\text{C}$ | | 122 | | ns |
| t_f | Current fall time | | | 146 | | ns |
| E_{off} | Turn-off switching energy | | | 1.06 | | mJ |
| t_{SC} | Short-circuit withstand time | $V_{CC} \leq 600 \text{ V}$, $V_{GE} \leq 15 \text{ V}$, $T_{Jstart} \leq 150 \text{ }^\circ\text{C}$ | 10 | | | μs |
| R_{THj-c} | Thermal resistance junction to case | Each IGBT | | 0.95 | 1.05 | $^\circ\text{C}/\text{W}$ |
| R_{THc-h} | Thermal resistance case to heatsink | Each IGBT, $\lambda_{grease} = 1 \text{ W}/(\text{m}\cdot^\circ\text{C})$ | | 0.90 | | $^\circ\text{C}/\text{W}$ |

1. Including the reverse recovery of the diode.
2. Including the tail of the collector current.

1.2.2 Diode
Table 7. Absolute maximum ratings of the diode, brake stage

| Symbol | Parameter | Value | Unit |
|----------------|---|------------|------|
| V_{RRM} | Repetitive peak reverse voltage | 1200 | V |
| I_F | Continuous forward current at ($T_C = 100\text{ °C}$) | 15 | A |
| $I_{FP}^{(1)}$ | Pulsed forward current ($t_p = 1\text{ ms}$) | 30 | A |
| T_{JMAX} | Maximum junction temperature | 175 | °C |
| T_{Jop} | Operating junction temperature range under switching conditions | -40 to 150 | °C |

1. Pulse width limited by maximum junction temperature.

Table 8. Electrical characteristics of the diode, brake stage

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit | | |
|------------------------|--------------------------------------|---|-----------|--------------------------|------|---------------|--|---------------|
| $V_F(\text{terminal})$ | Forward voltage | $I_F = 15\text{ A}$ | - | 3.0 | 3.8 | V | | |
| | | $I_F = 15\text{ A}, T_J = 150\text{ °C}$ | - | 2.1 | | | | |
| t_{rr} | Reverse recovery time | $I_F = 15\text{ A}, V_R = 600\text{ V}, V_{GE} = \pm 15\text{ V},$ $di/dt = 820\text{ A}/\mu\text{s}$ | - | 190 | | ns | | |
| Q_{rr} | Reverse recovery charge | | - | 1.45 | | μC | | |
| I_{rrm} | Reverse recovery current | | - | 23 | | A | | |
| E_{rec} | Reverse recovery energy | | - | 0.55 | | mJ | | |
| t_{rr} | Reverse recovery time | $I_F = 15\text{ A}, V_R = 600\text{ V}, V_{GE} = \pm 15\text{ V},$ $di/dt = 690\text{ A}/\mu\text{s}, T_J = 150\text{ °C}$ | - | 400 | | ns | | |
| | | | Q_{rr} | Reverse recovery charge | - | 2.75 | | μC |
| | | | I_{rrm} | Reverse recovery current | - | 25 | | A |
| | | | E_{rec} | Reverse recovery energy | - | 1.2 | | mJ |
| R_{THJ-c} | Thermal resistance junction-to- case | Each diode | - | 1.60 | 1.75 | °C/W | | |
| R_{THc-h} | Thermal resistance case-to-heatsink | Each diode, $\lambda_{grease} = 1\text{ W}/(\text{m}\cdot\text{°C})$ | - | 1.15 | | °C/W | | |

1.3 Converter stage

Limiting values at $T_J = 25\text{ °C}$, unless otherwise specified.

Table 9. Absolute maximum ratings of the bridge rectifiers

| Symbol | Description | Value | Unit |
|------------|--|------------|------------------|
| V_{RRM} | Repetitive peak reverse voltage | 1600 | V |
| I_F | RMS forward current | 30 | A |
| I_{FSM} | Forward surge current $t_p = 10\text{ ms}$, $T_C = 25\text{ °C}$ | 315 | A |
| | Forward surge current $t_p = 10\text{ ms}$, $T_C = 150\text{ °C}$ | 250 | |
| I^2t | $t_p = 10\text{ ms}$, $T_C = 25\text{ °C}$ | 496 | A ² s |
| | $t_p = 10\text{ ms}$, $T_C = 150\text{ °C}$ | 312 | |
| T_{JMAX} | Maximum junction temperature | 175 | °C |
| T_{Jop} | Operating junction temperature range under switching conditions | -40 to 150 | °C |

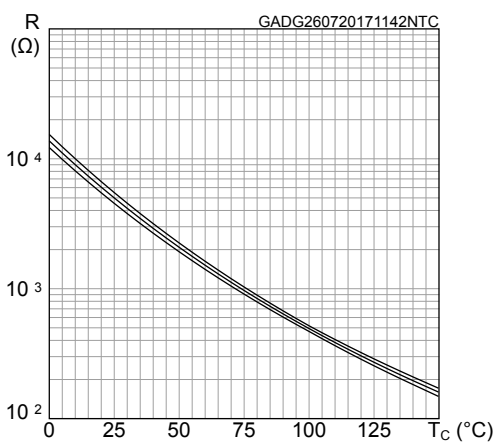
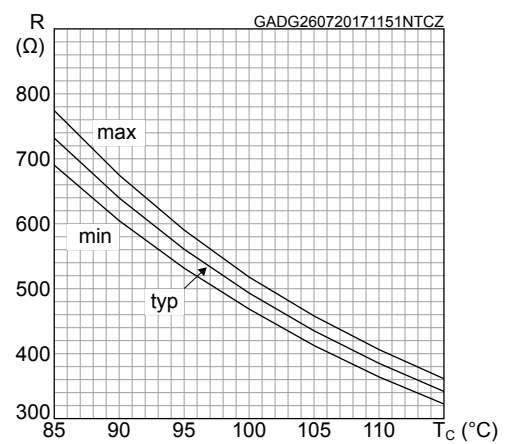
Table 10. Electrical characteristics of the bridge rectifiers

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|---------------------|-------------------------------------|---|------|------|------|------|
| V_F (terminal) | Forward voltage | $I_F = 15\text{ A}$ | - | 0.97 | 1.4 | V |
| | | $I_F = 15\text{ A}$, $T_J = 150\text{ °C}$ | - | 0.85 | | |
| I_R | Reverse current | $T_J = 150\text{ °C}$, $V_R = 1600\text{ V}$ | - | 1 | | mA |
| R_{THj-c} | Thermal resistance junction-to-case | Each diode | - | 1.20 | 1.35 | °C/W |
| R_{THc-h} | Thermal resistance case-to-heatsink | Each diode, $\lambda_{grease} = 1\text{ W/(m}\cdot\text{°C)}$ | - | 1.15 | | °C/W |

1.4 NTC

Table 11. NTC temperature sensor, considered as stand-alone

| Symbol | Parameter | Test condition | Min. | Typ. | Max. | Unit |
|--------------------|-------------------------------|----------------|------|------|------|------|
| R ₂₅ | Resistance | T = 25 °C | | 5 | | kΩ |
| R ₁₀₀ | Resistance | T = 100 °C | | 493 | | Ω |
| ΔR/R | Deviation of R ₁₀₀ | | -5 | | +5 | % |
| B _{25/50} | B-constant | | | 3375 | | K |
| B _{25/80} | B-constant | | | 3411 | | K |
| T | Operating temperature range | | -40 | | 150 | °C |

Figure 3. NTC resistance vs temperature

Figure 4. NTC resistance vs temperature, zoom


1.5 Package

Table 12. ACEPACK™ 1 package

| Symbol | Parameter | Min. | Typ. | Max. | Unit |
|-------------------|--|------|------|------|------|
| V _{isol} | Isolation voltage (AC voltage, t = 60 s) | | | 2500 | V |
| T _{stg} | Storage temperature | -40 | | 125 | °C |
| CTI | Comparative tracking index | 200 | | | |
| L _s | Stray inductance module P1 - EW loop | | 28.7 | | nH |
| R _s | Module single lead resistance , terminal to chip | | 3.9 | | mΩ |

2 Electrical characteristics (curves)

Figure 5. IGBT output characteristics
($V_{GE} = 15\text{ V}$, terminal)

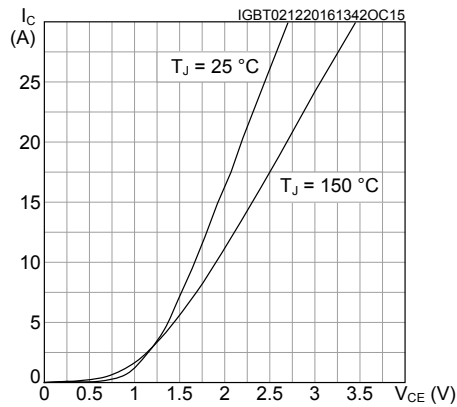


Figure 6. IGBT output characteristics
($T_J = 150\text{ }^\circ\text{C}$, terminal)

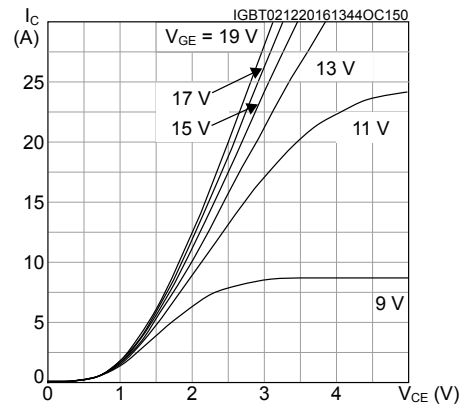


Figure 7. IGBT transfer characteristics
($V_{CE} = 15\text{ V}$, terminal)

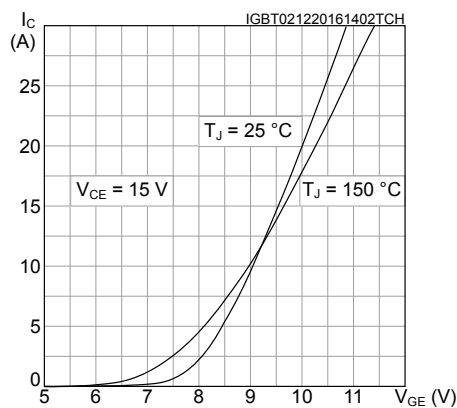


Figure 8. IGBT collector current vs case temperature

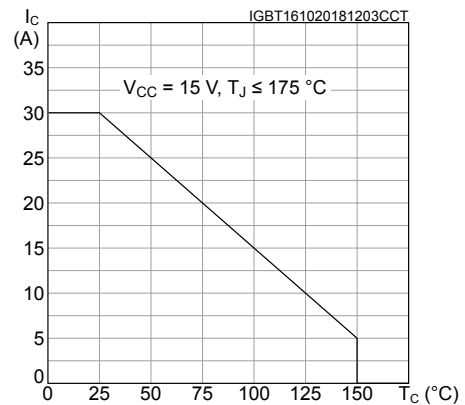


Figure 9. Switching energy vs gate resistance

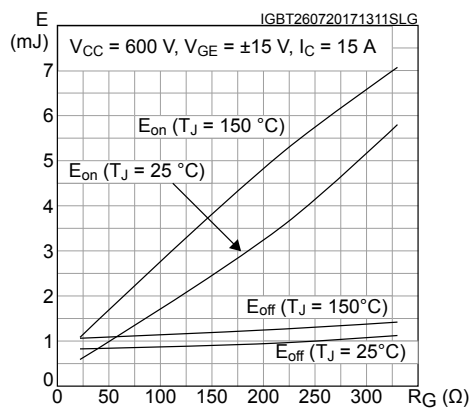


Figure 10. Switching energy vs collector current

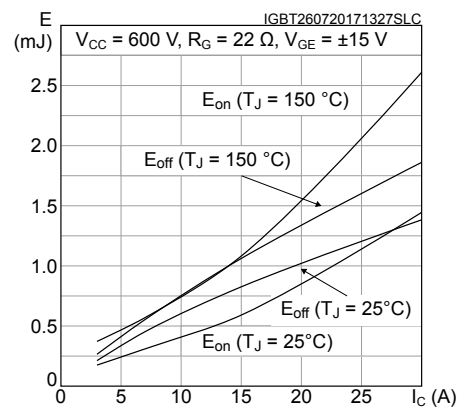


Figure 11. IGBT reverse biased safe operating area (RBSOA)

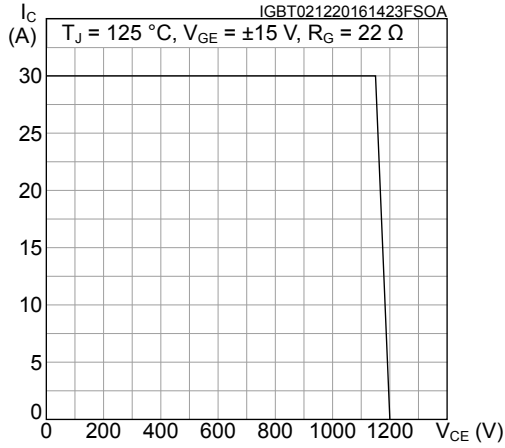


Figure 12. Diode forward characteristics (terminal)

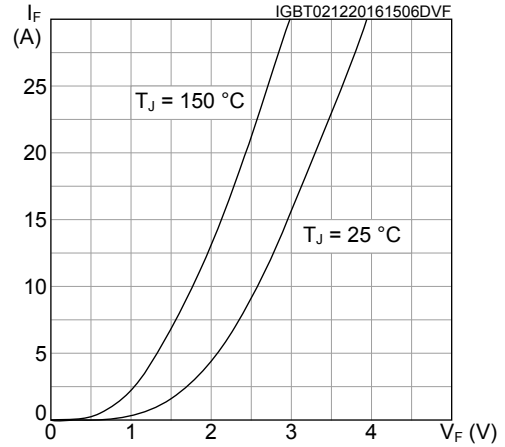


Figure 13. Diode reverse recovery energy vs diode current slope

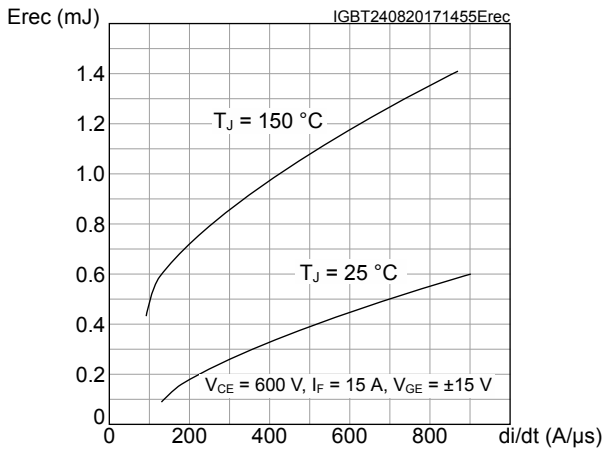


Figure 14. Diode reverse recovery energy vs forward current

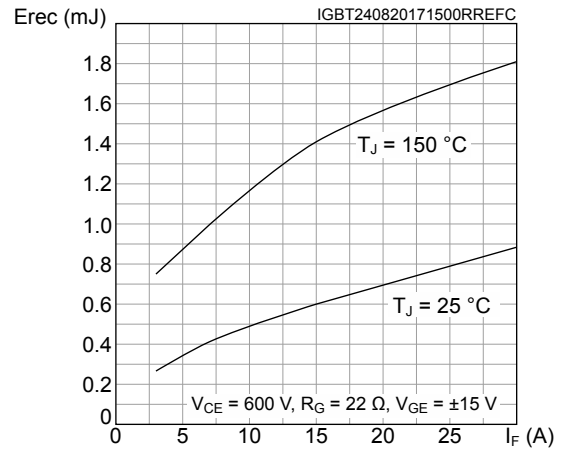


Figure 15. Diode reverse recovery energy vs gate resistance

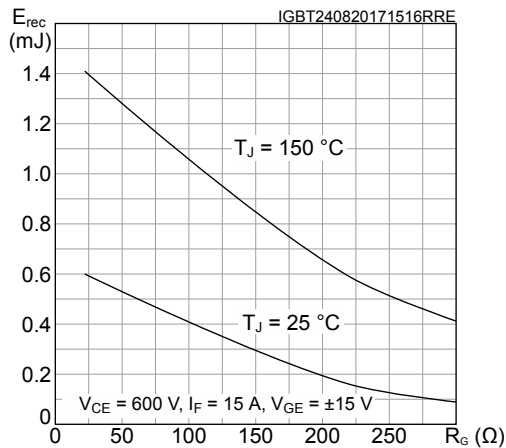


Figure 16. Converter diode forward characteristics (terminal)

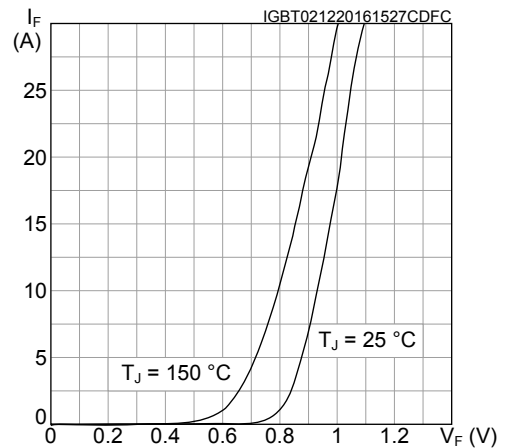


Figure 17. IGBT thermal impedance

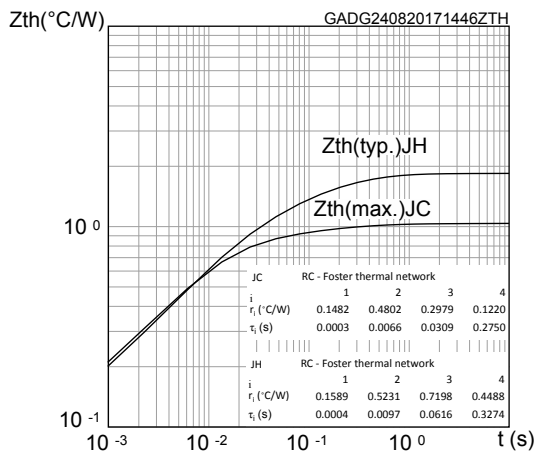
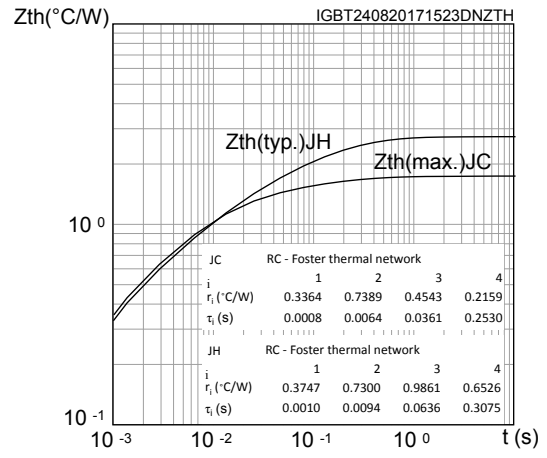
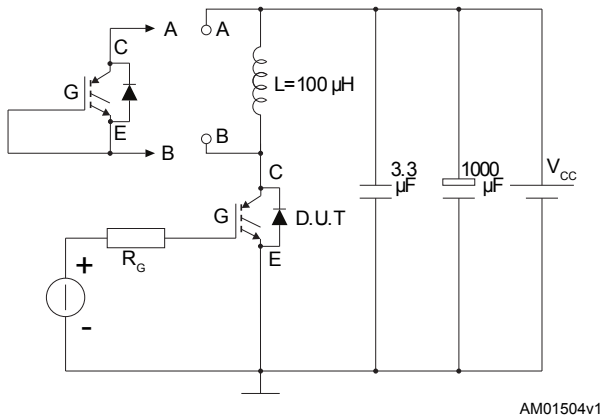
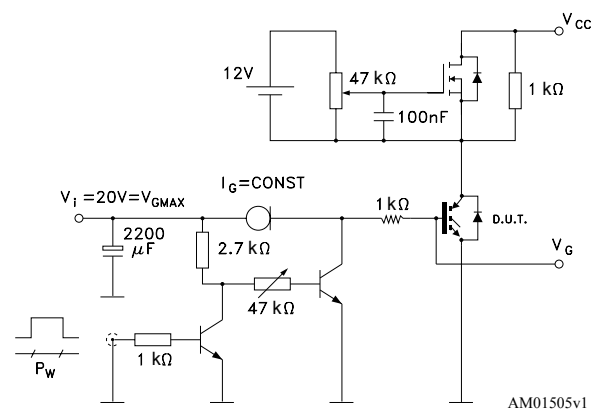
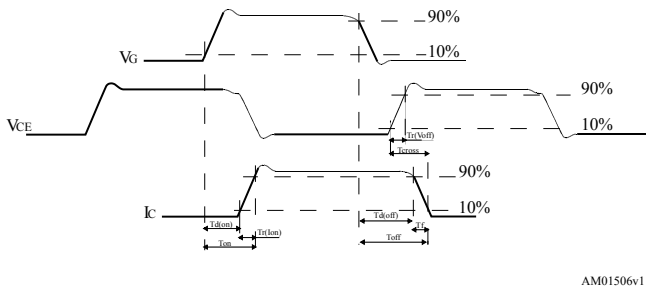
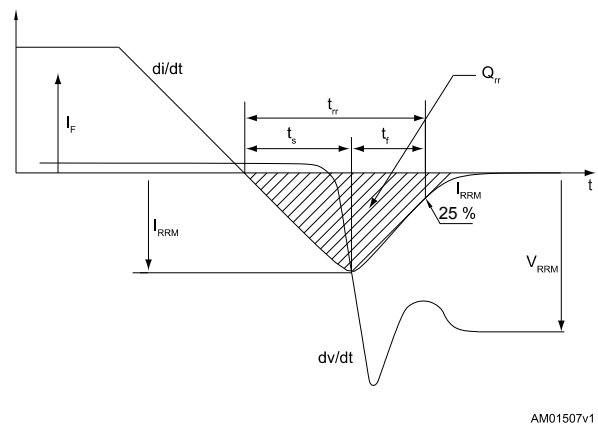


Figure 18. Inverter diode thermal impedance



3 Test circuits

Figure 19. Test circuit for inductive load switching

Figure 20. Gate charge test circuit

Figure 21. Switching waveform

Figure 22. Diode reverse recovery waveform


4 Topology and pin description

Figure 23. Electrical topology and pin description

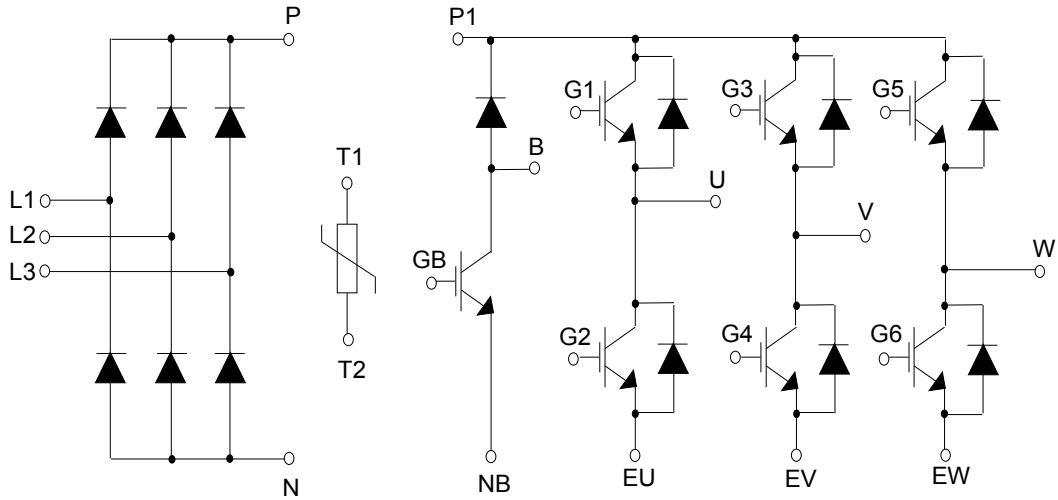
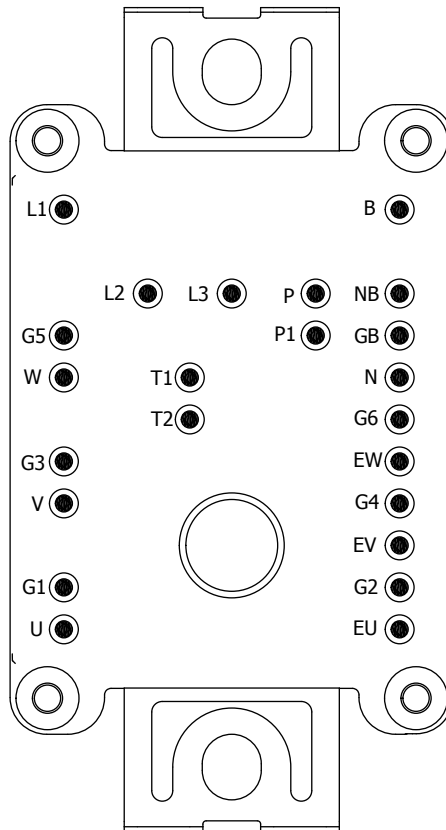


Figure 24. Package top view with CIB pinout



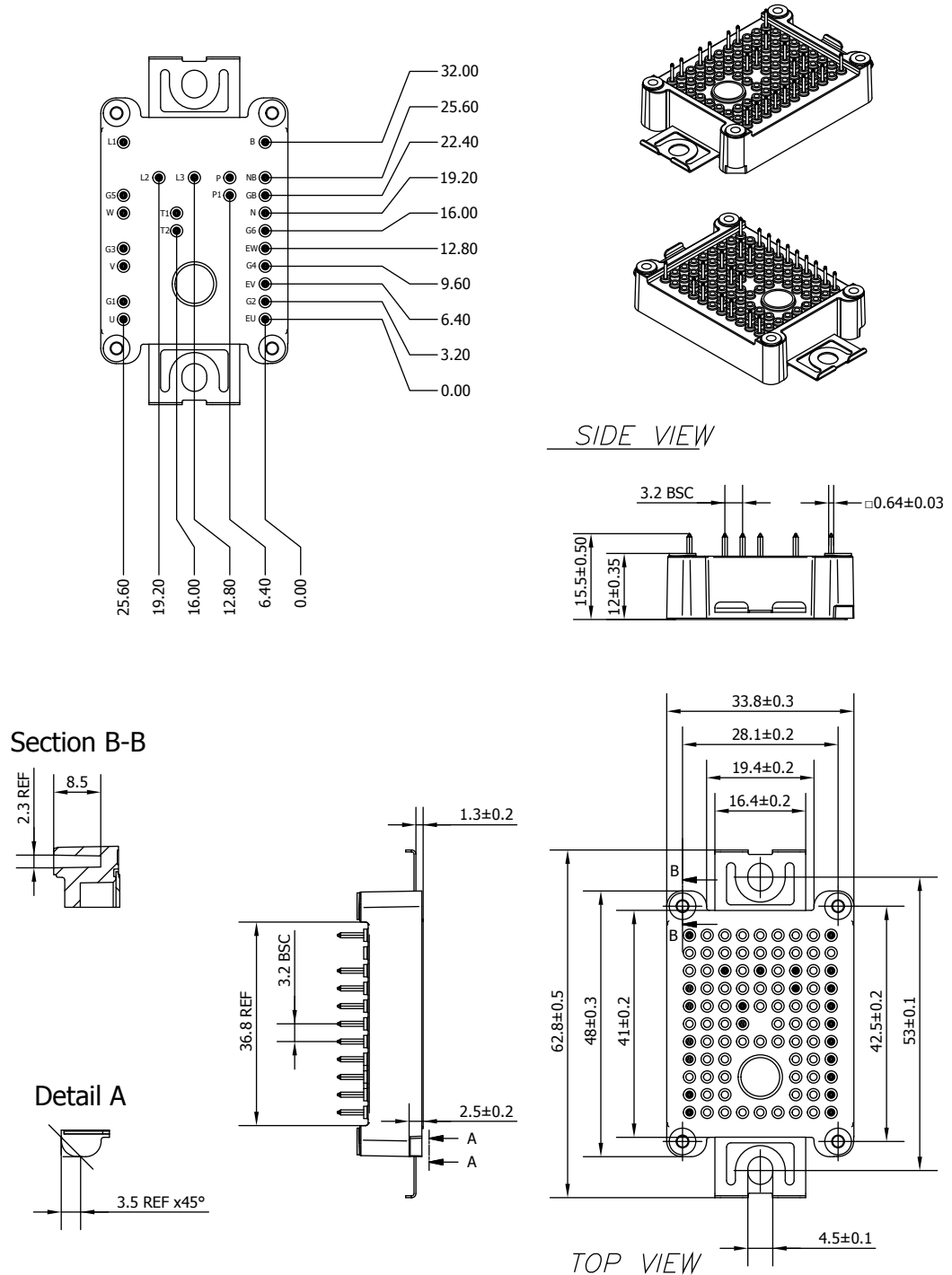
GIPD270320151420FSR

5 **Package information**

In order to meet environmental requirements, ST offers these devices in different grades of **ECOPACK®** packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

5.1 ACEPACK™ 1 CIB solder pins package information

Figure 25. ACEPACK™ 1 CIB solder pins package outline (dimensions are in mm)



GADG110720171247SA_8569715_4

- The lead size includes the thickness of the lead plating material.
- Dimensions do not include mold protrusion.
- Package dimensions do not include any eventual metal burrs.

Revision history

Table 13. Document revision history

| Date | Revision | Changes |
|-------------|----------|--|
| 02-May-2016 | 1 | Initial release. |
| 10-Mar-2017 | 2 | Added Section 2: "Electrical characteristics curves" and Section 3: "Test circuits". Updated Section 5.1: "ACEPACK™ 1 CIB solder pins package information". Minor text changes. |
| 26-Jul-2017 | 3 | Datasheet promoted from preliminary data to production data. Modified Table 2: "Absolute maximum ratings of the IGBTs, inverter stage", Table 3: "Electrical characteristics of the IGBTs, inverter stage", Table 6: "Absolute maximum ratings of the IGBT, brake stage", Table 7: "Electrical characteristics of the IGBT, brake stage", Table 4: "Absolute maximum ratings of the diode, inverter stage", Table 5: "Electrical characteristics of the diode, inverter stage", Table 10: "Absolute maximum ratings of the bridge rectifiers", Table 11: "Electrical characteristics of the bridge rectifiers", Table 12: "NTC temperature sensor, considered as stand-alone", Table 13: "ACEPACK™ 1 package". Modified Figure 10: "IGBT thermal impedance" and. Modified Figure 22: "Package top view with CIB pinout". Modified Section 5: "Package information". Minor text changes. |
| 24-Aug-2017 | 4 | Updated Table 3: "Electrical characteristics of the IGBTs, inverter stage", Table 5: "Electrical characteristics of the diode, inverter stage", Table 7: "Electrical characteristics of the IGBT, brake stage", Table 9: "Electrical characteristics of the diode, brake stage", Table 11: "Electrical characteristics of the bridge rectifiers", Section 2: "Electrical characteristics curves". Minor text changes. |
| 05-Oct-2017 | 5 | Updated Table 13: "ACEPACK™ 1 package", Figure 15: "IGBT thermal impedance" and Figure 16: "Inverter diode thermal impedance". Minor text changes. |
| 13-Feb-2018 | 6 | Updated Figure 16. IGBT thermal impedance and Figure 17. Inverter diode thermal impedance. Removed maturity status indication from cover page. Minor text changes. |
| 17-Oct-2018 | 7 | Added Figure 8. IGBT collector current vs case temperature. Minor text changes |

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